



#### **General Description**

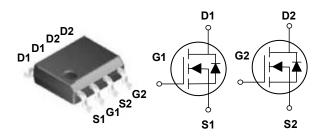
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>
30 V	13 mΩ	10 A

#### **Features**

- $\cdot R_{DS(ON)} \le 13m\Omega@V_{GS} = 10V$
- · Improved dv/dt capability
- · Fast switching
- · Green Device Available

#### SOP-8 Pin Configuration



#### **Applications**

- · MB / VGA / Vcore
- · POL Applications
- SMPS 2<sup>nd</sup> SR

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	±20	V
I_	Drain Current - Continuous (T <sub>C</sub> =25°C)	10	Α
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> =100°C)	6.3	Α
I <sub>DM</sub>	Drain Current - Pulsed (NOTE 1)	40	Α
EAS	Single Pulse Avalanche Energy (NOTE 2)	13	mJ
IAS	Single Pulse Avalanched Current (NOTE 2)	16	Α
$P_{D}$	Power Dissipation (T <sub>C</sub> =25°C)	2.1	W
' D	Power Dissipation - Derate above 25°C	0.017	W/°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
/larking Code		NC013, DS3810	

Thermal Characteristics					
Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		60	°C/W	





#### Electrical Characteristics (T<sub>.1</sub>=25°C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =250uA	30			V
I <sub>DSS</sub>	IDrain-Source Leakage Current	$V_{DS}$ =30V , $V_{GS}$ =0V , $T_J$ =25 $^{\circ}$ C			1	uA
		$V_{DS}$ =30V , $V_{GS}$ =0V , $T_J$ =125°C			10	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ =±20V , $V_{DS}$ =0V			±100	nA

#### On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I Regions	Static Drain-Source On-Resistance	$V_{GS}$ =10V , $I_D$ =8A			13	mΩ
	(NOTE 3)	$V_{GS}$ =4.5V , $I_D$ =4A			20	11122
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	1.2	1.8	2.5	V
gfs	Forward Transconductance	$V_{DS}$ =10V , $I_{D}$ =3A		6		S

#### **Dynamic and switching Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$Q_g$	Total Gate Charge	\\ -15\\ \\ -45\\ \ \-50		7.4	12	
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =5A (NOTE 3 \ 4)		2.3	5	nC
$Q_{gd}$	Gate-Drain Charge	(NOTE 3 · 4)		3	6	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_{G}$ =6 $\Omega$ , $I_{D}$ =1A (NOTE 3 $^{\circ}$ 4)		3.8	7	
T <sub>r</sub>	Rise Time			10	19	nS
$T_{d(off)}$	Turn-Off Delay Time			22	42	113
T <sub>f</sub>	Fall Time			6.6	13	
C <sub>iss</sub>	Input Capacitance			620	900	
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ =25V , $V_{GS}$ =0V , F=1MHz		85	125	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			60	90	
Rg	Gate resistance	V <sub>GS</sub> =0V , V <sub>DS</sub> =0V , F=1MHz		2.8	5.6	Ω

#### **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			10	Α
I <sub>SM</sub>	Pulsed Source Current (NOTE 3)				40	Α
$V_{SD}$	Diode Forward Voltage (NOTE 3)	$V_{GS}$ =0V , $I_{S}$ =1A , $T_{J}$ =25 $^{\circ}$ C			1	V

#### NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2.  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =16A,  $R_{G}$ =25 $\Omega$ , Starting  $T_{J}$ =25 $^{\circ}$ C.
- 3. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- 4. Essentially independent of operating temperature.





#### **Characteristics Curves**

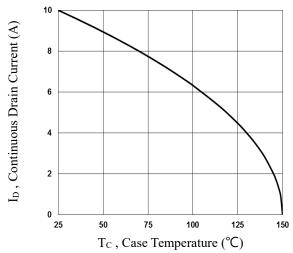


Fig.1 Continuous Drain Current vs. Tc

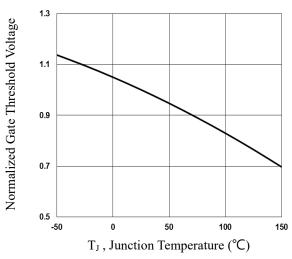


Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>

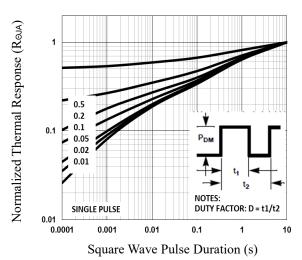


Fig.5 Normalized Transient Response

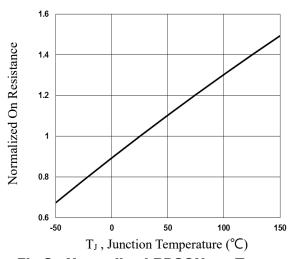


Fig.2 Normalized RDSON vs. T<sub>J</sub>

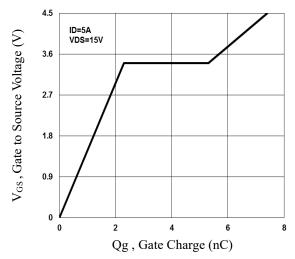


Fig.4 Gate Charge Waveform

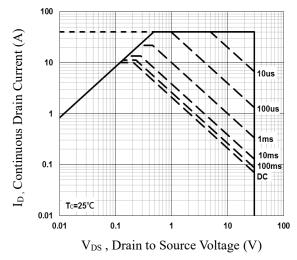


Fig.6 Maximum Safe Operation Area





#### **Characteristics Curves**

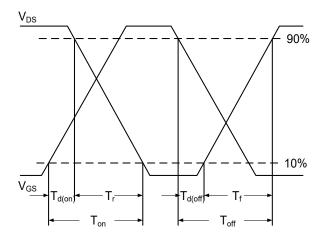
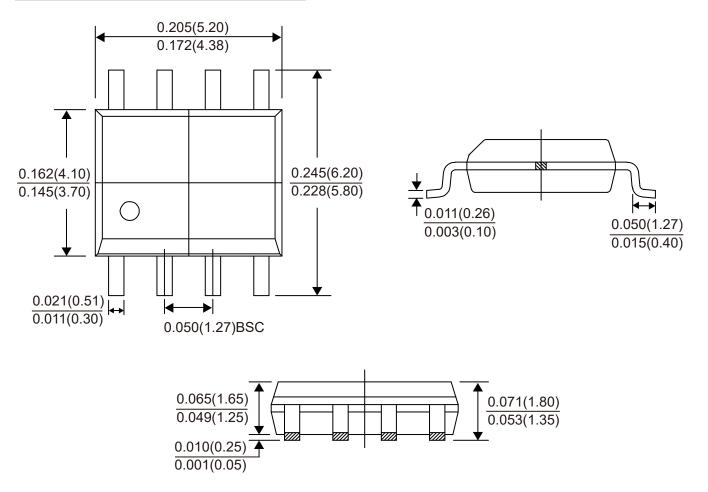


Fig.7 Switching Time Waveform

#### **Package Outline Dimensions**



**SOP-8**Dimensions in inches and (millimeters)





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